TO-252



2SK4018-VB Datasheet

N-Channel 100 V (D-S) MOSFET

D

GO

| PRODUCT SUMMARY | | | | | |
|---------------------|----------------------------------|--------------------|-----------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) | Q _g (Typ.) | | |
| | 0.055 at V _{GS} = 10 V | 25 | | | |
| 100 | 0.057 at V _{GS} = 4.5 V | 25 | 21nC | | |
| | | | | | |

FEATURES

- Trench power MOSFET
- 100 % UIS tested



APPLICATIONS

• Primary side switch

| Top View | S N-Channel MOSFET | | | | |
|---|---|------------------|---------------------|----|--|
| | | | | | |
| ABSOLUTE MAXIMUM RATIN | GS (T _A = 25 °C, unless | s otherwise note | ed) | | |
| PARAMETER | SYMBOL | LIMIT | UNIT | | |
| Drain-Source Voltage | V _{DS} | 100 | V | | |
| Gate-Source Voltage | V _{GS} | ± 20 | v | | |
| | T _C = 25 °C | | 25 | | |
| Continuous Drain Current (T, = 175 °C) | T _C = 70 °C | | 20 | | |
| Continuous Drain Current $(1) = 173$ C) | T _A = 25 °C | 'D | 12 ^{b, c} | | |
| | T _A = 70 °C | | 10 ^{b, c} | A | |
| Pulsed Drain Current | I _{DM} | 75 | A | | |
| | T _C = 25 °C | | 50 ^e | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 6.9 ^{b, c} | | |
| Avalanche Current Pulse | L = 0.1 mH | I _{AS} | 33 | | |
| Single Pulse Avalanche Energy | | E _{AS} | 55 | mJ | |
| | T _C = 25 °C | | 83 | | |
| Maximum Power Dissipation | T _C = 70 °C | P _D | 58 | w | |
| Maximum Fower Dissipation | T _A = 25 °C | | 8.3 ^{b, c} | vv | |
| | T _A = 70 °C |] [| 5.8 ^{b, c} | | |
| Operating Junction and Storage Temperat | T _J , T _{stg} | -55 to +175 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------------|--------------|-------------------|---------|---------|------|--|
| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT | |
| Maximum Junction-to-Ambient b, d | t ≤ 10 s | R _{thJA} | 15 | 18 | °C/W | |
| Maximum Junction-to-Case | Steady State | R _{thJC} | 1.5 | 1.8 | C/ W | |

Notes

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 50 °C/W.

e. Calculated based on maximum junction temperature. Package limitation current is 50 A.

2SK4018-VB

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|---|-------------------------------------|---|------|-------|-------|-------|--|
| Static | | | - | | - | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS}=0~V,~I_D=250~\mu A$ | 100 | - | - | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_J$ | L 050 | - | 165 | - | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | - | -11 | - | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 1.0 | | 3.5 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | - | - | ± 100 | nA | |
| Zero Gate Voltage Drain Current | lana | $V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | - | 1 | | | |
| Zero Gale Voltage Drain Gurrent | I _{DSS} | V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 55 °C | - | - | 10 | μA | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$ | 25 | - | - | A | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12 \text{ A}$ | - | 0.055 | Ω | | |
| | V_{GS} =4.5 V, I _D =8A | | | 0.057 | | | |
| Forward Transconductance ^a | g fs | $V_{DS} = 15 \text{ V}, \text{ I}_{D} = 12 \text{ A}$ | - | 25 | - | S | |
| Dynamic ^b | 1 1 | | | | | I | |
| Input Capacitance | C _{iss} | | - | 1800 | - | pF | |
| Output Capacitance | Coss | V_{DS} = 12 V, V_{GS} = 0 V, f = 1 MHz | - | 180 | - | | |
| Reverse Transfer Capacitance | C _{rss} | | - | 60 | - | | |
| Total Gate Charge | Qg | | - | 21 | 32 | nC | |
| Gate-Source Charge | Q _{gs} | V_{DS} = 50 V, V_{GS} = 10 V, I_{D} = 12 A | - | 10 | - | | |
| Gate-Drain Charge | Q _{gd} | | - | 9 | - | | |
| Gate Resistance | Rg | f = 1 MHz | - | 1.5 | - | Ω | |
| Turn-On Delay Time | t _{d(on)} | | - | 10 | 15 | | |
| Rise Time | t _r | $V_{DD} = 50 \text{ V}, \text{ R}_{L} = 5 \Omega$ | - | 10 | 15 | - ns | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 10$ A, V_{GEN} = 10 V, R_g = 1 Ω | - | 15 | 25 | | |
| Fall Time | t _f | | - | 10 | 15 | | |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous Source-Drain Diode Current | ا _S | T _C = 25 °C | - | - | 50 | _ | |
| Pulse Diode Forward Current ^a | I _{SM} | | - | - | 40 | A | |
| Body Diode Voltage | V _{SD} | I _S = 10 A | - | 0.8 | 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | - | 50 | 75 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | | - | 100 | 150 | nC | |
| Reverse Recovery Fall Time | t _a | I _F = 10 A, di/dt = 100 A/μs, T _J = 25 °C | - | 38 | - | | |
| Reverse Recovery Rise Time | t _b | | - | 12 | - | ns | |

Note

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$

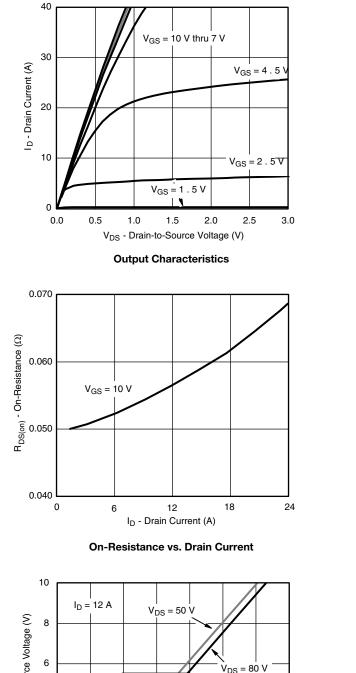
b. Guaranteed by design, not subject to production testing.

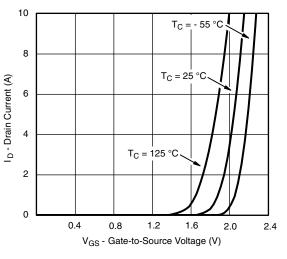
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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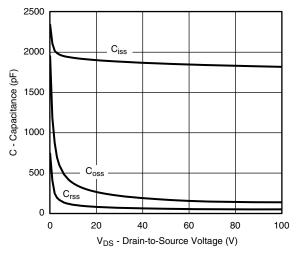




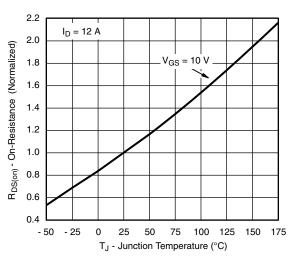




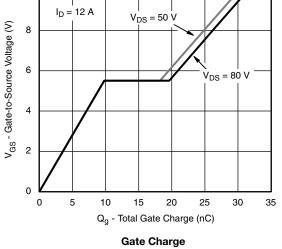
Transfer Characteristics



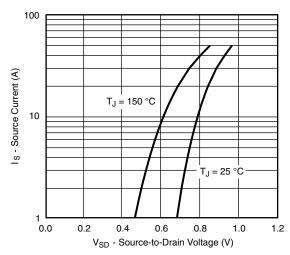




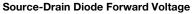
On-Resistance vs. Junction Temperature

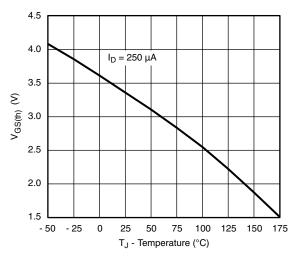




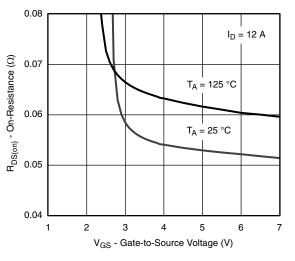


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

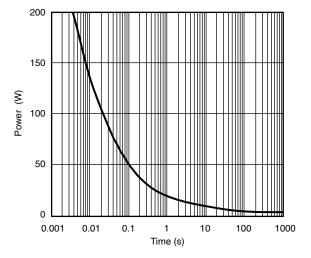




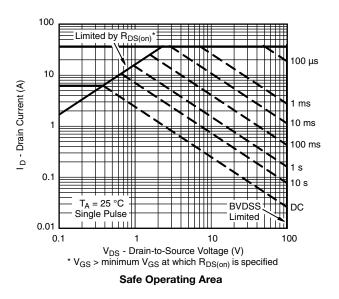




R_{DS(on)} vs. V_{GS} vs. Temperature

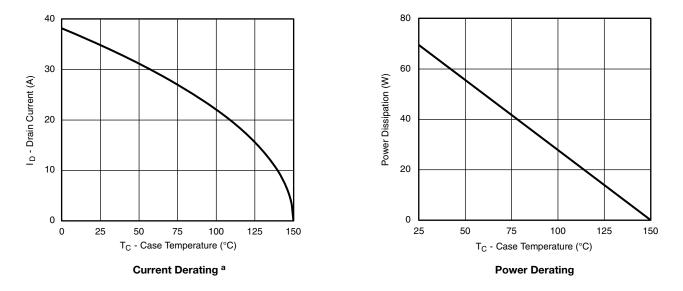


Single Pulse Power, Junction-to-Ambient





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

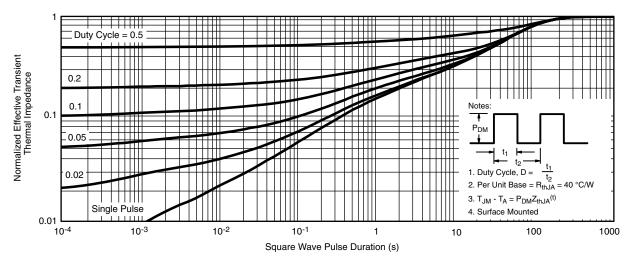


Note

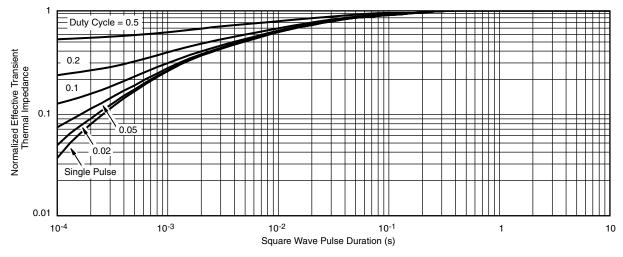
a. The power dissipation P_D is based on T_J (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

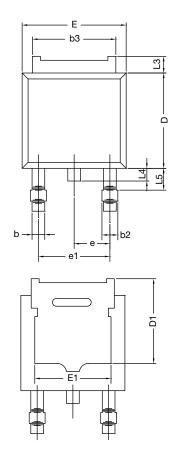


Normalized Thermal Transient Impedance, Junction-to-Ambient

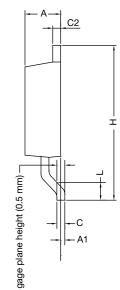


Normalized Thermal Transient Impedance, Junction-to-Case





TO-252AA Case Outline



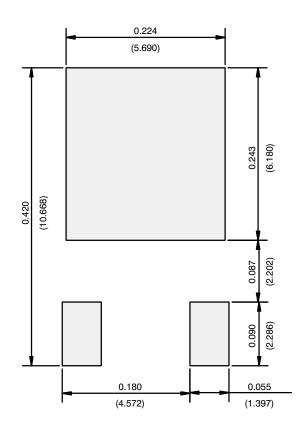
| | MILLIN | IETERS | INCHES | | |
|--|--------|----------|-----------|-----------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| А | 2.18 | 2.38 | 0.086 | 0.094 | |
| A1 | - | 0.127 | - | 0.005 | |
| b | 0.64 | 0.88 | 0.025 | 0.035 | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | |
| С | 0.46 | 0.61 | 0.018 | 0.024 | |
| C2 | 0.46 | 0.89 | 0.018 | 0.035 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | |
| D1 | 4.10 | - | 0.161 | - | |
| Е | 6.35 | 6.73 | 0.250 | 0.265 | |
| E1 | 4.32 | - | 0.170 | - | |
| Н | 9.40 | 10.41 | 0.370 | 0.410 | |
| е | 2.28 | BSC | 0.090 BSC | | |
| e1 | 4.56 | 4.56 BSC | | 0.180 BSC | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 | |
| L4 | - | 1.02 | - | 0.040 | |
| L5 | 1.01 | 1.52 | 0.040 | 0.060 | |
| ECN: T16-0236-Rev. P, 16-May-16 DWG: 5347 | | | | | |

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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